

Shenzhen Leadtek Electronics Co.,Ltd

PRODUCT SPECIFICATION

TFT-LCD MODULE

Module No: LTK056PDHLM10-V0

☒ Preliminary Specification

☐ Approval Specification

Designed by	Checked by	Approved by
<i>jona</i>	<i>Jerry</i>	<i>lan</i>

Final Approval by Customer

Approved by	Comment

※The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.



1.Document Revision History

Version	Contents	Date	Note
V0	Initial version	2024.07.16	



2.GENERAL INFORMATION

N0	Item	Specification	Unit	Remark
1	LCD Size	TFT"5.6	inch	-
2	Panel Type	TN	-	-
3	Display Resolution	720 x RGB x 1440	pixel	-
4	Display mode	Normally White	-	-
5	Display colors	16.7M	-	-
6	Viewing Direction	ALL	-	-
7	LCM Module Size	64.24 (W) x130.51(H) x1.62(T)	mm	Note
8	Active Area	120.96(W)*60.48(H)	mm	Note
9	Pixel Pitch	0.084(W)*0.084(H)	mm	-
10	Weight	TBD	g	-
11	Driver IC	-	bit	-
12	Light Source	White LED	-	-
13	Interface	MIPI 4 Lanes	-	-

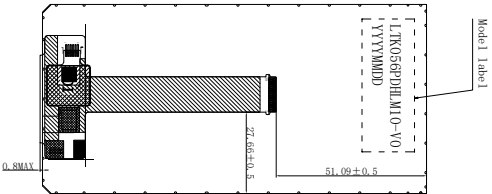
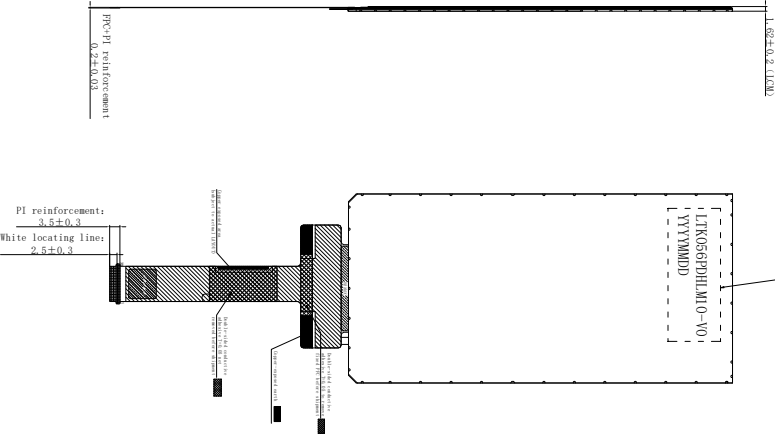
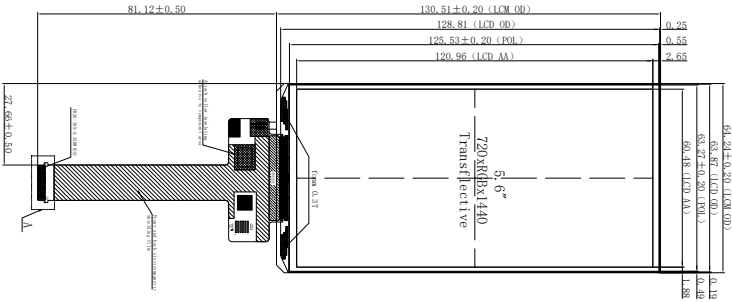
3.Mechanical Drawing

Front View

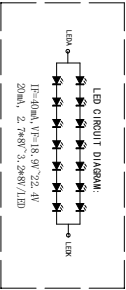
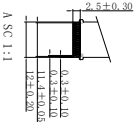
Side View

Back View

Back View



- Notes:
1. Display: 5.6", TFT
 2. Resolution: 720*RGB*1440
 3. LCD Viewing Direction: 60/60/60/60
 4. Display Mode: Normally White
 5. LCM Brightness: 80cd/m² (TYP), Uniformity ≥80%
 6. Unmarked tolerance: ±0.2
 7. Operating Temperature: -20℃ ~ +70℃
 8. Storage Temperature: -30℃ ~ +80℃
 9. Requirements on Environmental Protection: ROHS



No.	PIN NAME
1	GND
2	D2P
3	D2N
4	GND
5	D1P
6	D1N
7	GND
8	CLKP
9	CLKN
10	GND
11	D0P
12	D0N
13	GND
14	D3P
15	D3N
16	GND
17	ID
18	RESET
19	TE
20	GND
21	IOVCC1.8V
22	GND
23	NC
24	AVEE
25	AVDD
26	NC
27	LEDK
28	LEDK
29	LEDA
30	NC
31	GND
32	TP-RST 1.8V
33	TP-INT 1.8V
34	GND
35	TP-SDA 1.8V
36	TP-SCL 1.8V
37	GND
38	TP-VDD 2.8V
39	GND

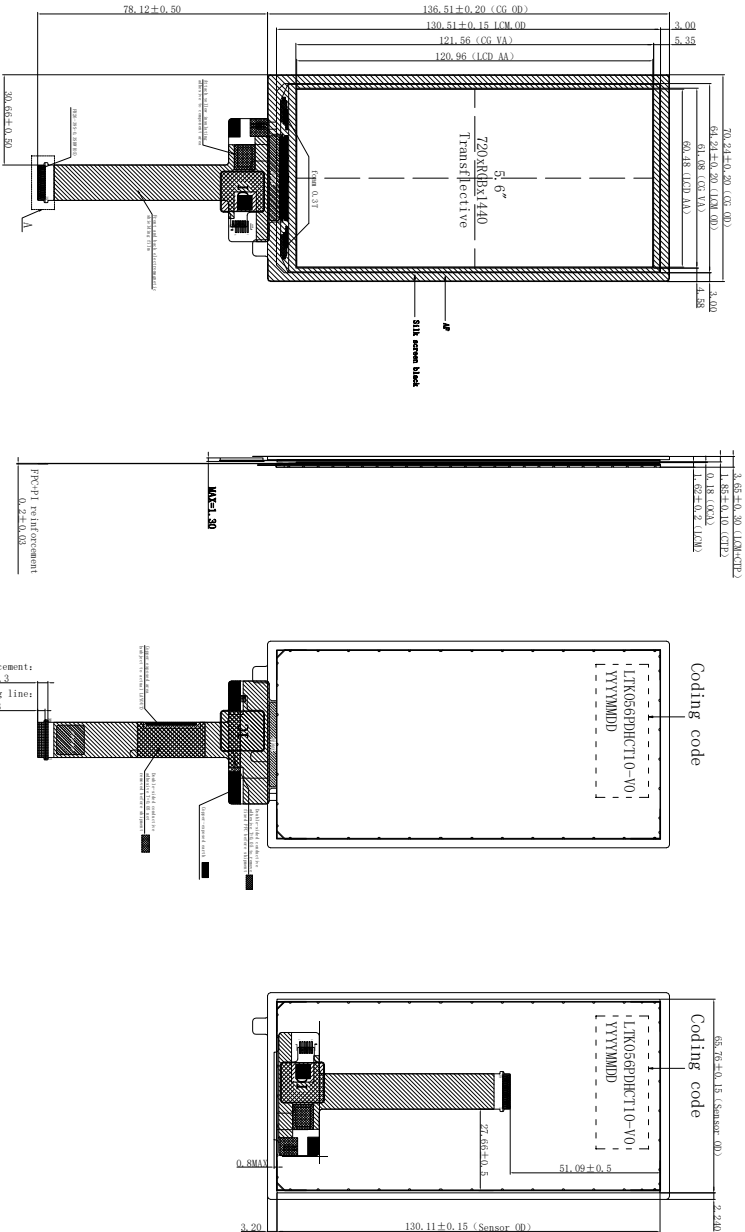
3			
2			
1			
0			
REV	DESCRIPTION	DATE	NAME



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SCALE: 1/1	UNIT: mm	PAGE: 1/1	APPROVE	CHECK	DRAWN
Part No:	LTK056PDHLM10	VER: V0			
Customer No:			Ian	Kevin	Jerry

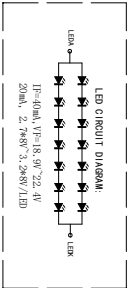
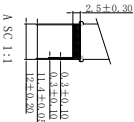
Front ViewSide ViewBack ViewBack View



- CTP Technical requirements:
- Structure: G+G.
 - Transmittance: $\geq 86\%$ (550nm).
 - All unmarked tolerances: $\pm 0.10\text{mm}$
 - IC: G1911, 5-point touch
 - Temperability: 110g steel ball, height 30cm drop without breaking, surface hardness
 - Test: $\geq 6\text{H}$ (pencil hardness test).
 - CG unmarked key holes and edge safety inverted $\leq 0.10\text{mm}$.

Notes:

- Display: 5.6", TFT
- Resolution: 720*RGB*1440
- LCD Viewing Direction: 60/60/60/60
- Display Mode: Normally White
- LCM+CTP Brightness: 70cd/m² (TYP), Uniformity $\geq 80\%$
- Unmarked tolerance: ± 0.2
- Operating Temperature: $-20^{\circ}\text{C}^{\sim} +70^{\circ}\text{C}$
- Storage Temperature: $-30^{\circ}\text{C}^{\sim} +80^{\circ}\text{C}$
- Requirements on Environmental Protection: ROHS



PIN Definition

PIN	NAME
1	VDD-3.3V
2	SDA-1.8V
3	SCL-1.8V
4	GND
5	INT
6	RESET

No.: PIN NAME

1	GND
2	D2P
3	D2N
4	GND
5	D1P
6	D1N
7	GND
8	CLKP
9	CLKN
10	GND
11	D0P
12	D0N
13	GND
14	D3P
15	D3N
16	GND
17	ID
18	RESET
19	TE
20	GND
21	IOVCC1.8V
22	GND
23	NC
24	AVEE
25	AVDD
26	NC
27	LEBK
28	LEDK
29	LEDA
30	NC
31	GND
32	TP-RST 1.8V
33	TP-INT 1.8V
34	GND
35	TP-SDA 1.8V
36	TP-SCL 1.8V
37	GND
38	TP-VDD 2.8V
39	GND

3	
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1	
0	NEW
REV	DESCRIPTION

2024.03.20	Jerry
DATE	NAME



LEADTEK COMPANY LIMITED

SCALE: 1/1	UNIT: mm	PAGE: 1/1	Approve	Check	Drawn
Part No:	LTK056PDHCT10	VER: V0			
Customer No:			Ian	Kevin	Jerry

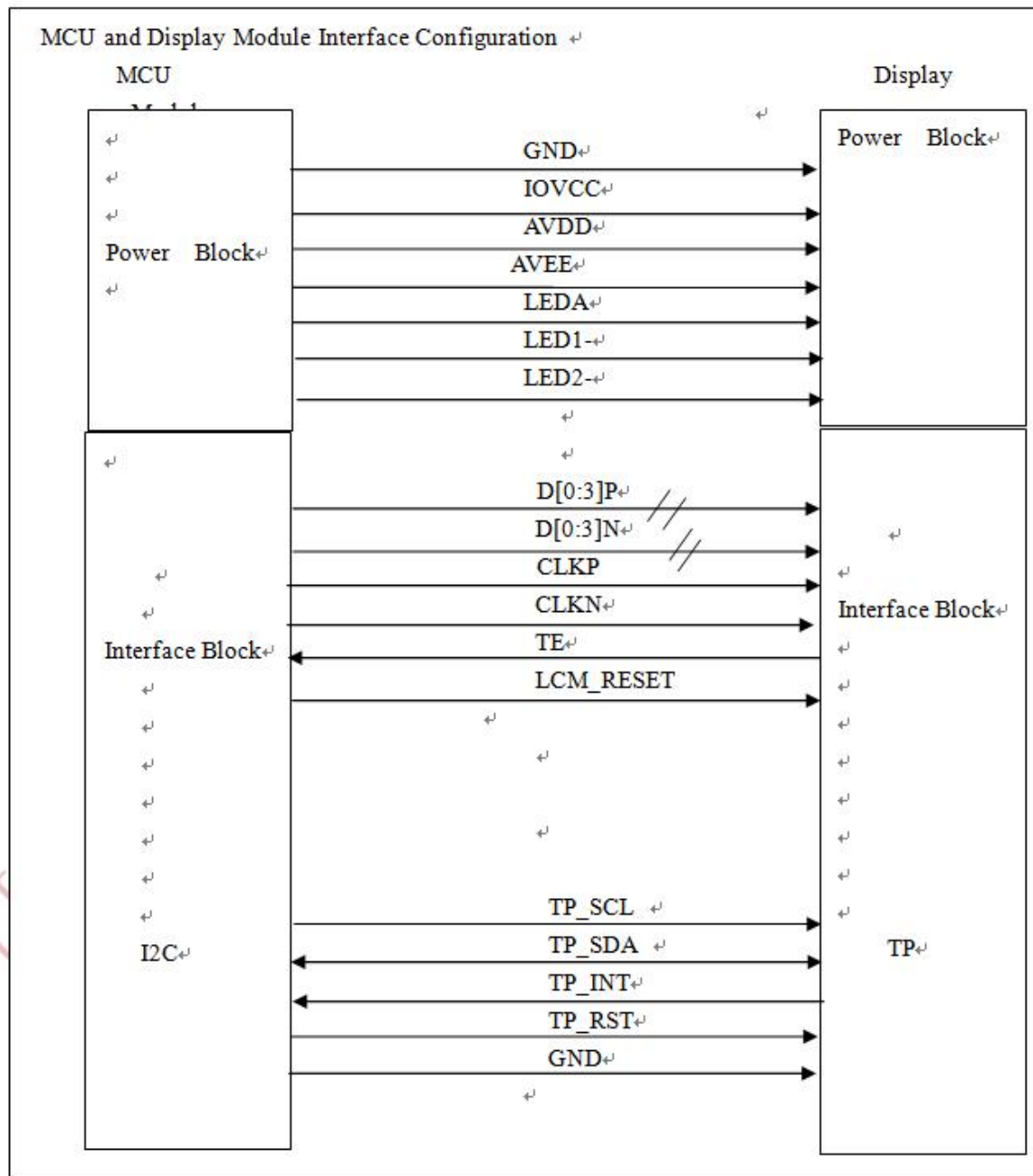
4. I/O CONNECTION & BLOCK DIAGRAM

4.1 I/O Connection

Pin No.	Symbol	I/O	Description
1	GND	P	Power Ground
2	D2P	I	MIPI-DSI data lane 2 positive-end input pin
3	D2N	I	MIPI-DSI data lane2 negative-end input pin
4	GND	P	Power Ground
5	D1P	I	MIPI-DSI data lane 1 positive-end input pin
6	D1N	I	MIPI-DSI data lane1 negative-end input pin
7	GND	P	Power Ground
8	CLKP	I	MIPI-DSI data clock lane positive-end input pin
9	CLKN	I	MIPI-DSI data clock lane negative-end input pin
10	GND	P	Power Ground
11	D0P	I/O	MIPI-DSI data lane 0 positive-end input pin
12	D0N	I/O	MIPI-DSI data lane0 negative-end input pin
13	GND	P	Power Ground
14	D3P	I	MIPI-DSI data lane 3 positive-end input pin
15	D3N	I	MIPI-DSI data lane3 negative-end input pin
16	GND	P	Power Ground
17	ID	I	LCD ID
18	RESET	I	The signal will reset the LCM, Signal is active low.
19	TE	O	Tearing effect outputsignal. If not used, please let this pin
20	GND	P	Power Ground
21	IOVCC 1.8	P	Power supply for logic circuits and IO pads(1.8V)
22	GND	P	Power Ground
23	NC	-	No connected
24	AVEE	P	Negative input analog power for driver IC use
25	AVDD	P	Positive input analog power for driver IC use
26	NC	-	No connected
27-28	LEDK	P	Power supply for backlight cathode
29	LEDA	P	Power supply for backlight anode
30	NC	-	No connected
31	GND	P	Power Ground
32	NC	I	No connected
33	NC	O	INo connected
34	GND	P	Power Ground
35	NC	I	No connected
36	NC	I	No connected
37	GND	P	Power Ground
38	NC	P	No connected
39	GND	P	Power Ground

4.2 Block Diagram

MCU and Display Module Interface Configuration



5. ELECTRICAL CHARACTERISTICS

5.1 TFT-LCD Panel Driving Section

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Power Supply1 Voltage	IOVCC	1.65	1.8	2	V	-
Power Supply2 Voltage	AVDD	4.5	5.8	6	V	
Power Supply3 Voltage	AVEE	-4.5	-5.8	-6	V	
Power Supply1 Current	I _{VCI}		16.5		mA	
Power Supply2 Current	I _{AVDD}		10.5		mA	
Power Supply3 Current	I _{AVEE}		9.7		mA	
Logic Input High Voltage	V _{IH}	0.7IOVCC	-	IOVCC	V	-
Logic Input Low Voltage	V _{IL}	VSSD	-	0.3IOVCC	V	-

(Ta=+25°C,GND=0V)

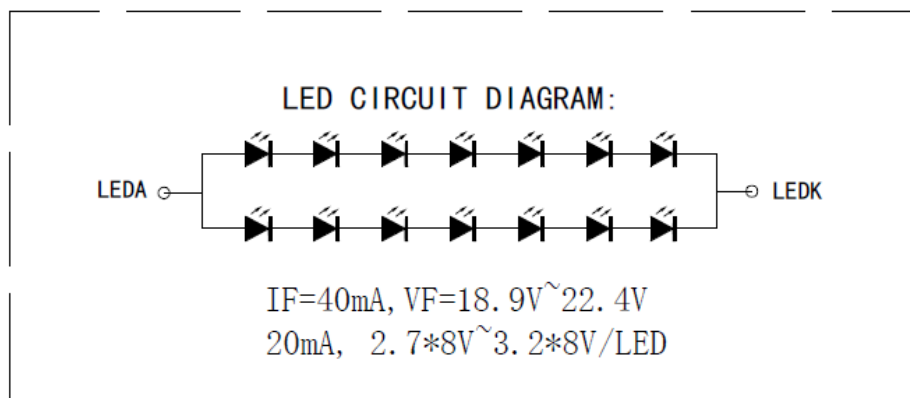
Note1:Measurement Conditions : Full Screen Red Pattern,IOVCC=1.8V,60Hz Refresh.

5.2 Back Light Driving Section

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Forward Voltage	V _F	-	18.9	22.4	V	
Forward Current	I _F	-	40	-	mA	
Backlight Luminance-LCM	P _{BL}	-	80	-	cd/m2	
LED life time	-	30000	-	-	Hours	
LED Quantity			14		PCS	

(Ta=+25°C,GND=0V)

Note1:The “LED life time” is defined as the module brightness decrease to 50% of original brightness at I_{LED}=20mA(Per Led). The LED life time could be decreased if operating I_{LED} is larger than 20mA.



5.3 Power On/Off Sequence

Power source IOVCC, VCI can be applied and powered down in any order. IOVCC, VCI can be powered down in any order.

During power off, if LCD is in the Sleep Out mode, IOVCC, VCI must be powered down minimum 120msec after NRESET has been released.

During power off, if LCD is in the Sleep In mode, IOVCC, VCI can be powered down minimum 0msec after NRESET has been released.

NCS can be applied at any timing or can be permanently grounded. NRESET has priority over NCS.

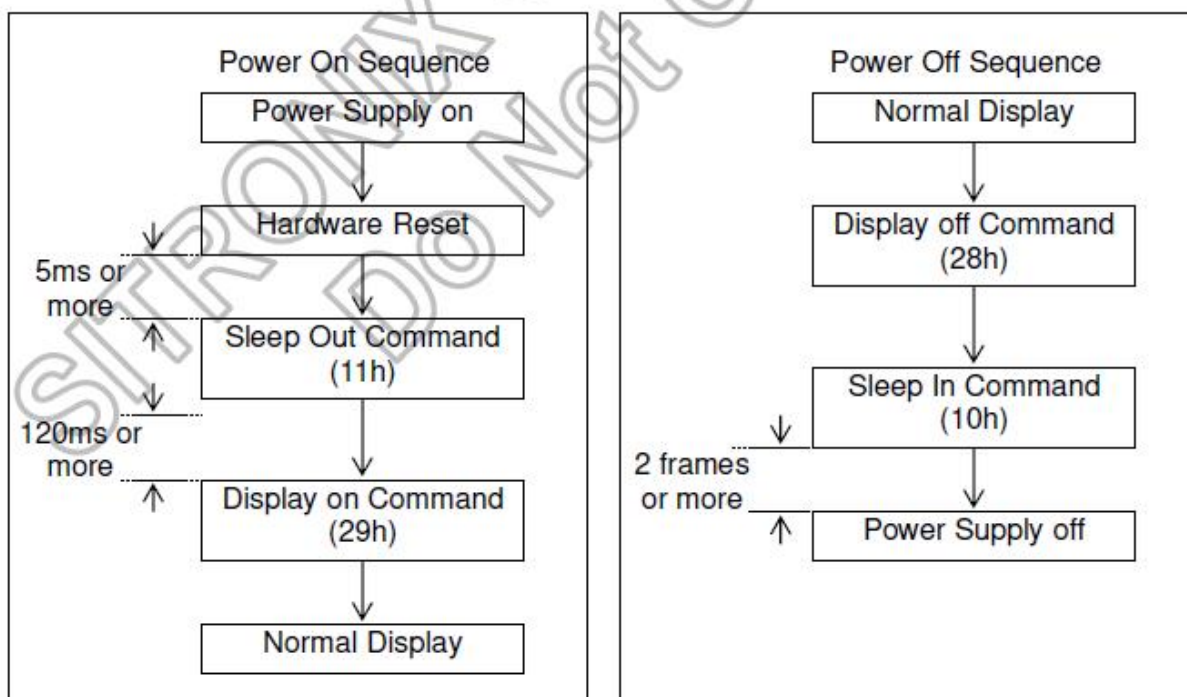


Figure 5.32: The power supply ON/OFF setting for Display ON/OFF and Sleep In/out

5.3.1 Case 1: RESX line is held high or unstable by host at power on

If RESX line is held high or unstable by the host during power on, then a Hardware Reset must be applied after both VDD1, VDD2 and VDD3 have been applied- otherwise correct functionality is not guaranteed. There is no timing restriction upon this hardware reset.

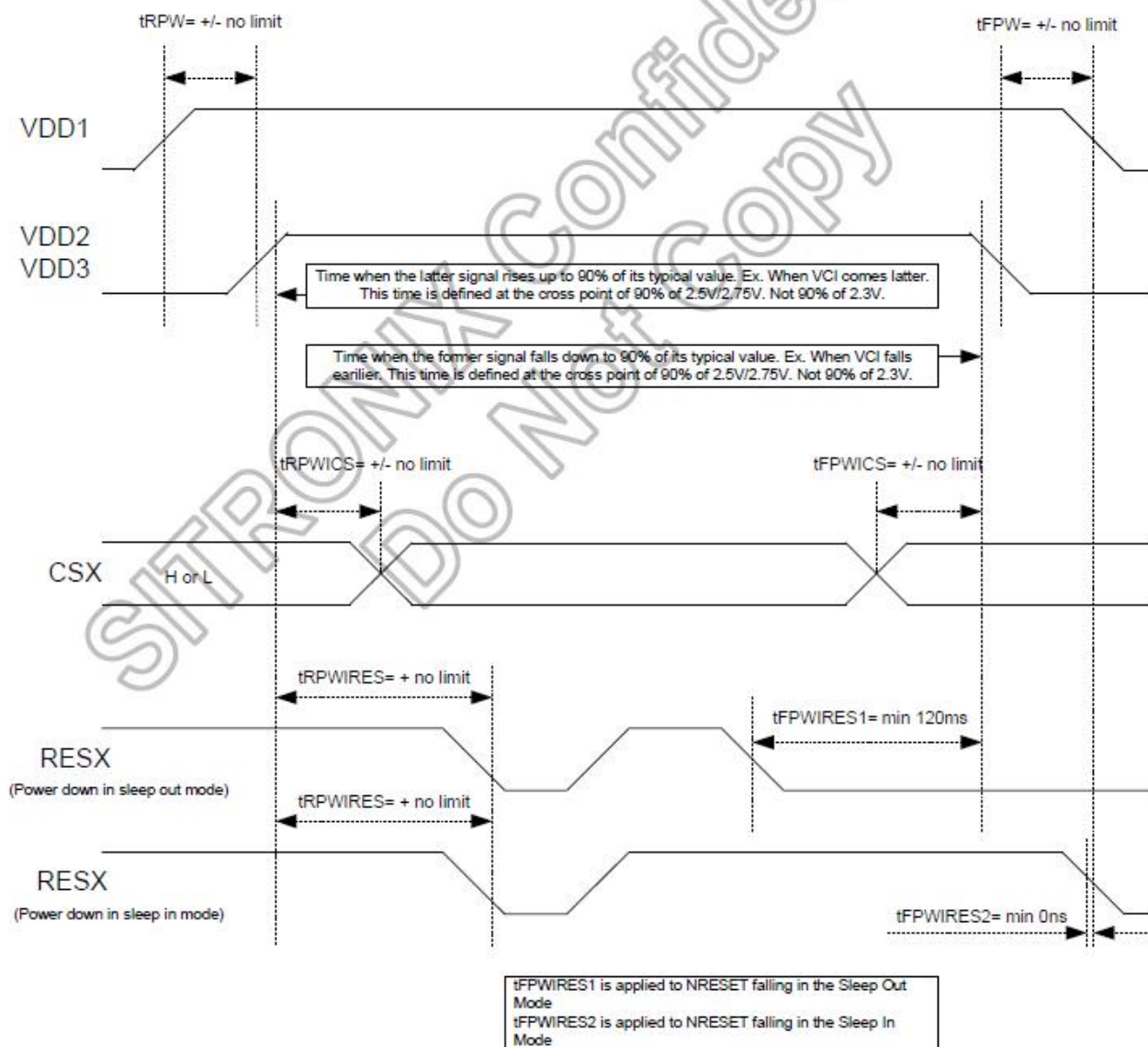
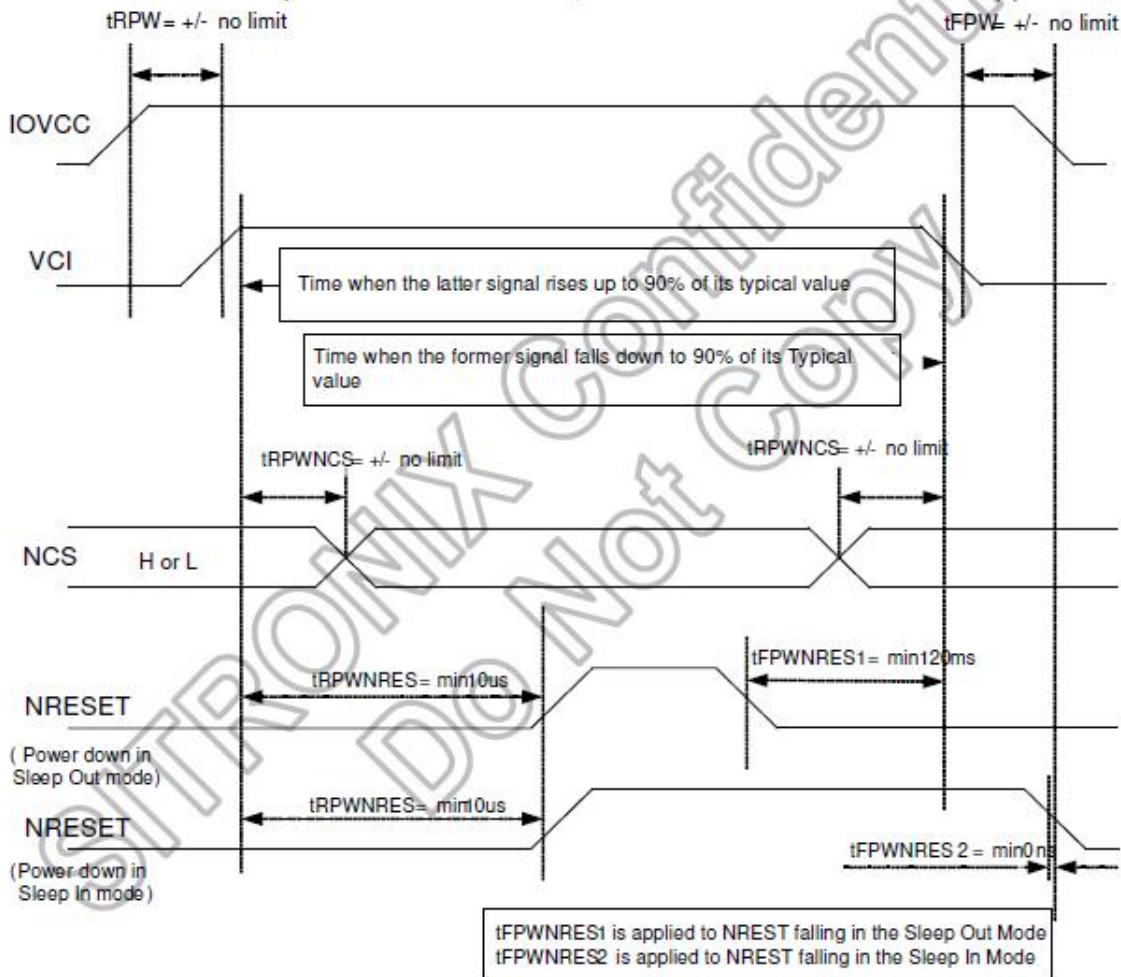


Figure 5.33: Case 1: RESX line is held high or unstable by host at power on

5.3.2 Case 2: RESX line is held low by host at power on

If RESX line is held low (and stable) by the host during power on, then the RESX must be held low for minimum 10 μ sec after both VDD1, VDD2 and VDD3 have been applied.



Note: Unless otherwise specified timings herein show cross point at 50% of signal/power level

Figure 5.34: Case 2: RESX line is held low by host at power on

5.4 AC Characteristics

High Speed Mode

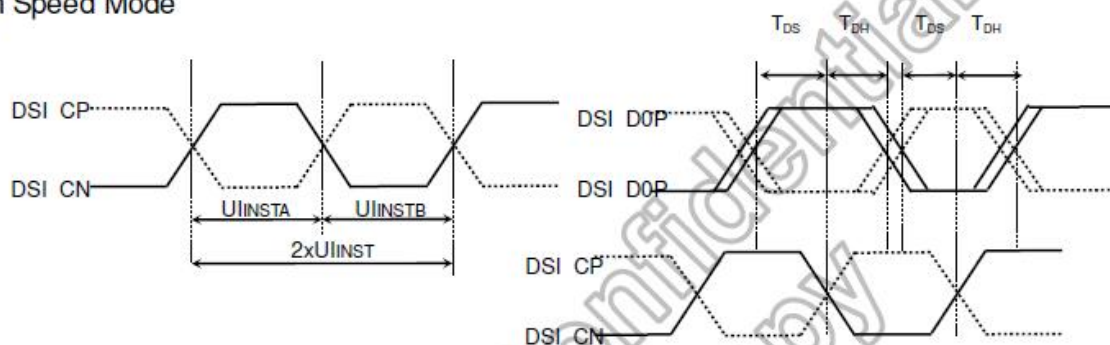


Figure 7.4: DSI clock timing Characteristics

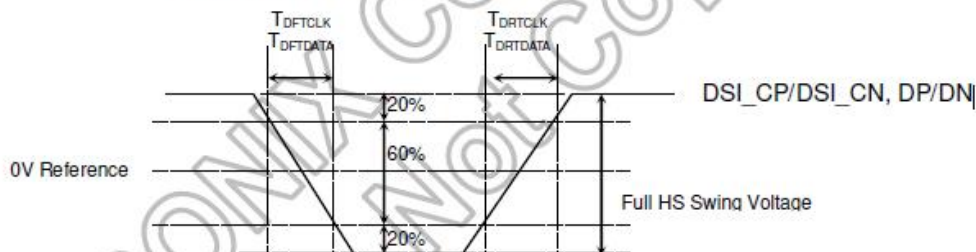


Figure 7.5: Rising and falling time on clock and data channel

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, TA = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Double UI instantaneous	2xUIINST	TBD	-	25	ns
	UI instantaneous	UIINSTA UIINSTB	TBD	-	12.5	ns
DP/DN	Data to clock setup time	T _{DS}	0.15xUI	-	-	ps
	Data to clock hold time	T _{DH}	0.15xUI	-	-	ps
DSI_CP/ DSI_CN	Differential rise time for clock	T _{DRTCLK}	150	-	0.3UI	ps
	Differential fall time for clock	T _{DFTCLK}	150	-	0.3UI	ps
DP/DN	Differential rise time for data	T _{DRTDATA}	150	-	0.3UI	ps
	Differential fall time for data	T _{DFTDATA}	150	-	0.3UI	ps

Table 7.3: DSI High Speed Mode Characteristics

Low Power Mode

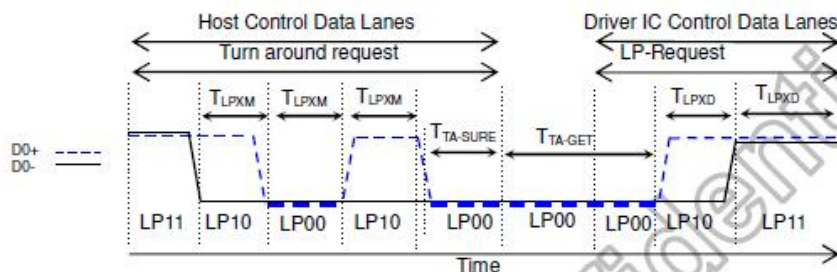


Figure 7.6: BTA from HOST to Display Module Timing

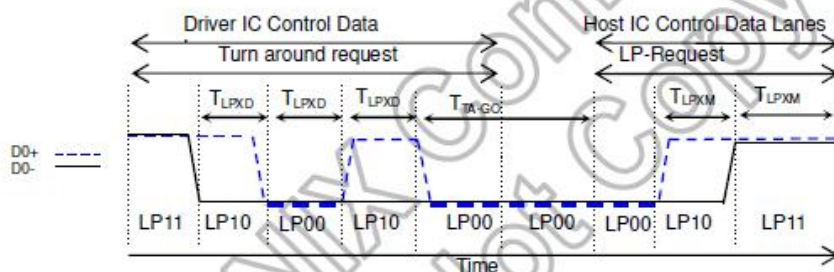


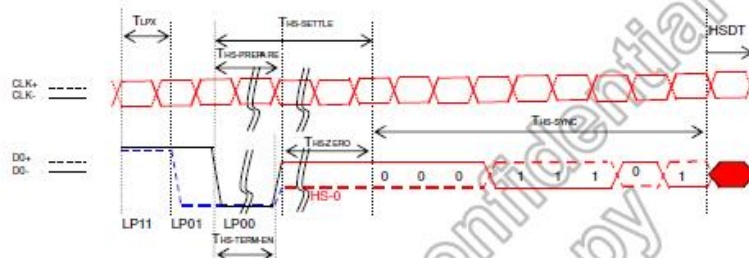
Figure 7.7: BTA from Display Module Timing to HOST

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V, $T_A = -30$ to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11 Host → Display module	TLPXM	50	-	-	ns
	Length of LP-00/LP01/LP10/LP11 Display module → Host	TLPXD	50	-	-	ns
	Time-out before the MPU start driver	T _{TA-SURE}	TLPXD	-	2xTLPXD	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xTLPXD	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TA-GET}	4xTLPXD	-	-	ns

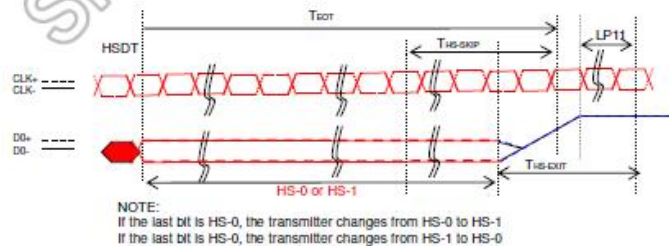
Table 7.4: DSI Low Power Mode Characteristics

DSI BURSTS



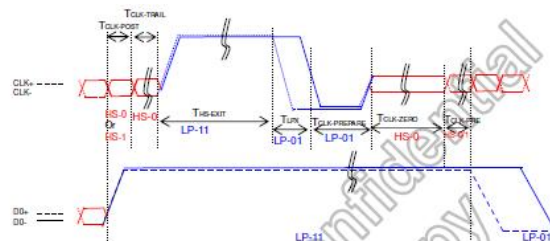
Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0N	Length of LP-00/LP01/LP10/LP11	TLPK	50	-	-	ns
	Time to Driver LP-00 to prepare for HS transmission	THS-PREPARE	40+4UI	-	85+6UI	ns
	Time to enable data receiver line termination	THS-TERMEN	-	-	35+4xUI	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xTLPK	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TAGO}	4xTLPK	-	-	ns

Table 7.5: DSI Low Power Mode to High Speed Mode Timing



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0N	Time-Out at Display Module to Ignore Transition Period of EoT	T _{HS-SKIP}	40	-	55+4xUI	ns
	Time to Driver LP-11 after HS Burst	T _{HS-EXIT}	100	-	-	ns

Table 7.6: DSI Low Power Mode to High Speed Mode Timing



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Time that the MCU shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	T _{CLK-POST}	60+52xUI	-	-	ns
	Time to drive HS differential state after last payload clock bit of a HS transmission burst	T _{CLK-TRAIL}	60	-	-	ns
	Time to drive LP-11 after HS burst	T _{HS-EXIT}	100	-	-	ns
	Time to drive LP-00 to prepare for HS transmission	T _{CLK-PREPARE}	38	-	95	ns
	Time-out at Clock-Lane Display Module to enable HS Termination	T _{CLK-TERMEN}	-	-	38	ns
	Minimum lead HS-0 drive period before starting Clock	T _{CLK-PREPARE} + T _{CLK-ZERO}	300	-	-	ns
	Time that the HS clock shall be driven prior to any associated data Lane beginning the transition from LP to HS mode	T _{CLK-PRE}	8xUI	-	-	ns

Table 7.7: Clock Lanes High Speed Mode to/from Low Power Mode Timing

5.5 DSI Power On/Off Timing

5.5.1 Power On Timing of External Power IC

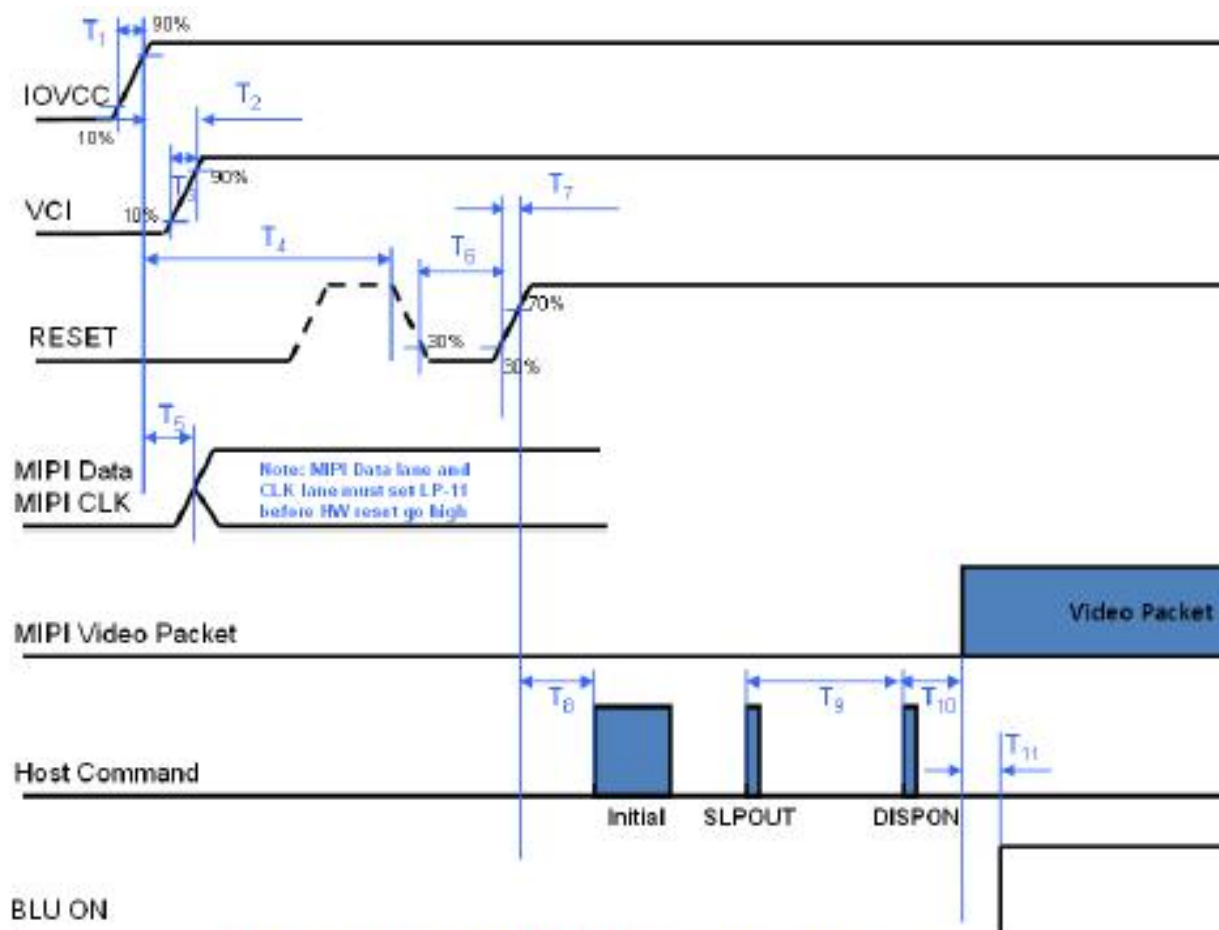


Figure 8-6: DSI Power On Sequence of Power IC Mode

	Min.	Typ.	Max.	Unit
T1	0.01	-	10	ms
T2	No Limit			ms
T3	0.01	-	10	ms
T4	1	-	-	ms
T5	1	-	-	ms
T6	10	-	-	us
T7	No Limit			ns
T8	15	-	-	ms
T9	120	-	-	ms
T10	No Limit			ms
T11	100	150	-	ms

Table 8-1: DSI Power On Timing of Power IC Mode

5.5.2 Power off Timing of External Power IC

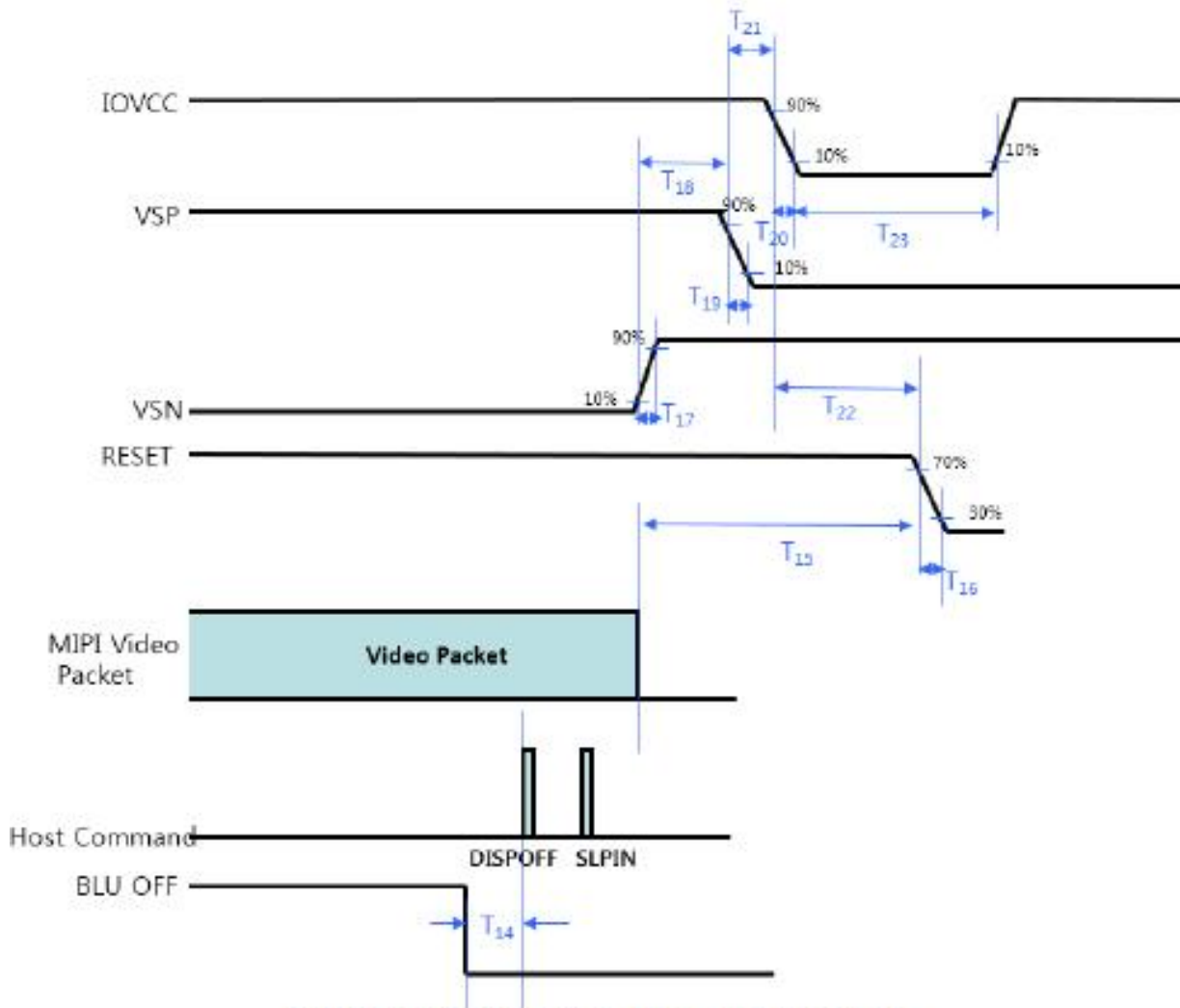


Figure 8-9: DSI Power Off Sequence of 3 Power Mode

	Min.	Typ.	Max.	Unit
T14	40	100	-	ms
T15	10	-	-	ms
T16	No Limit			ms
T17	No Limit			ms
T18	1	-	-	ms
T19	No Limit			ms
T20	No Limit			ms
T21	1	-	-	ms
T22	1	-	-	ms
T23	100	-	-	ms

Table 8-4: DSI Power Off Timing of 3 Power Mode

5.5.3 Timing Parameters

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Vertical low pulse width	VS	-	-	4	-	Line
Vertical front porch	VFP	-	-	32	-	Line
Vertical back porch	VBP	-	-	16	-	Line
Vertical active area	VDISP	-	-	720	-	Line
Vertical Refresh rate	VRR	-	-	60	-	Hz
HS low pulse width	HS	-	-	20	-	DCK
Horizontal back porch	HBP	-	-	40	-	DCK
Horizontal front porch	HFP	-	-	60	-	DCK
Horizontal active area	HDISP	-	-	1440	-	DCK

6. OPTICAL CHARACTERISTICS

6.1 Optical Specification (Reflective mode)

Parameter	Symbol	Condi on	Min.	Typ.	Max.	Unit	Remark
White Reflectance (with Polarizer)	R _w (%)	$\theta = 0$		8.5		%	
Contrast Ratio	C/R	$\theta = 0^\circ$	-	15:1	-	-	
NTSC Ratio	S	$\theta = 0^\circ$	-	14	-	%	
Response Time	T _R + T _F	25 °C	-	-	30	ms	设备: DMS T _R +T _F W90%/B10%
Viewing Angle	θ_L	C/R>2	-	55	-	Degree	设备: DMS Source pad Down CR>2
	θ_R		-	55	-		
	θ_U		-	55	-		
	θ_D		-	55	-		

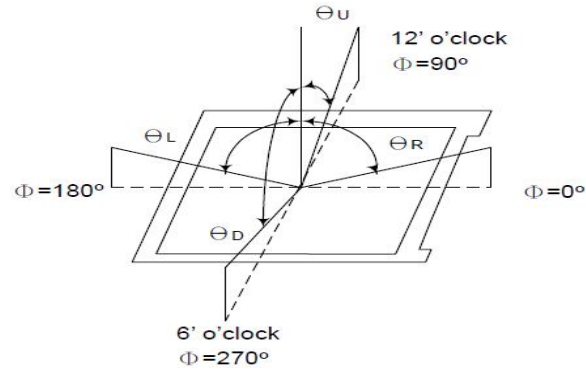
6.2 Optical Specification (Transmittance mode)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Contrast Ratio	C/R	$\theta = 0^\circ$		45:1	-	-	SR-UL1 R
NTSC Ratio	S	$\theta = 0^\circ$		18		%	
Luminance	L	$\theta = 0^\circ$		100	-	cd/m2	
Luminance uniformity	U_W	$\theta = 0^\circ$	80	-	-	%	Note(1)
Response Time	$T_{R+} T_F$	25 °C	-	-	30	ms	Note(2)
Color Coordination	W_X	$\theta = 0^\circ$	-+0.04	-	+0.04	NTSC (x,y)	Note(3)
	W_Y			-			
Viewing Angle	θL	C/R>2	-	60	-	Degree	设备: DMS source pad down CR>2
	θR			60			
	θU			60			
	θD			60			

Test Conditions:

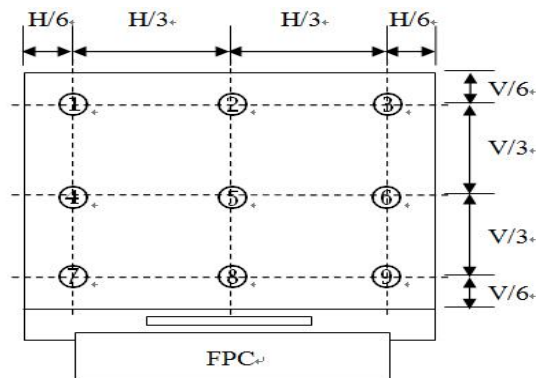
1. the ambient temperature is +25°C.
2. The test systems refer to Note 8.

Definition of Viewing Angle: The viewing angle range that the CR>2



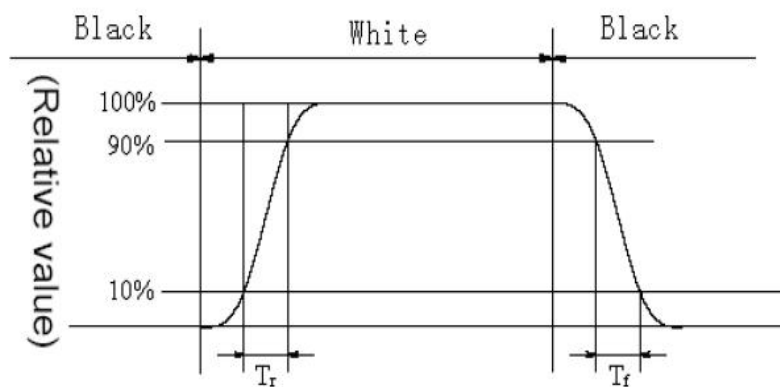
Note 1: Definition of Luminance Uniformity: Active area is divided into 9 measuring areas, every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity} = \frac{\text{Min Luminance of white among 9-points}}{\text{Max Luminance of white among 9-points}} \times 100\%$$



Note2: Definition of T_r and T_f

Response time: Sum of T_r



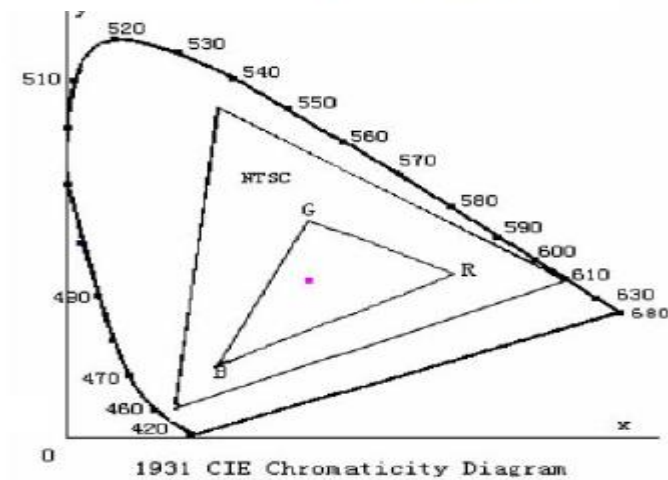
Note 3:

Definition of Color Chromaticity (CIE 1931)

Color coordinates of white & red, green, blue measured at center point of LCD.

Note 7: Definition of NTSC ratio:

$$\text{NTSC ratio} = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}}$$



7. RELIABILITY

Item	Test Condition	Remark
High Temperature Storage	Ta =+80°C / 96Hours	
Low Temperature Storage	Ta =-30°C / 96Hours	
High Temperature Operating	Ta =+70°C / 96Hours	
Low Temperature Operating	Ta =-20°C / 96Hours	
Temperature Cycle storage Test	-30°C/30min Δ+80°C /30min for 30cycles,Transfer time less than 5min	
Thermal humidity storage Test	60°C x 90%RH / 96Hours	
Package Vibration Test	Frequency: 10Hz~55Hz,Amplitude:1.5mm, 1 hrs for each direction of X, Y, Z	
Packing shock test	Drop to the ground from 1m height, 1 corner, 3 edges, 6 surfaces.	

Inspection after Test:

Note1:Ta is the ambient temperature of samples.

Note 2: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but doesn't guarantee all the cosmetic specification.

Note 3: Before cosmetic and function tests , the product must have enough recovery time, at least 2 hours at room temperature.

8.0 General Precaution

8.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life-threatening or otherwise catastrophic.

8.2 Assembly Precaytton

- 1、 Please use the mounting hole on the module side in installing and do not bending or wrenching LCD in assembling. And please do not drop, bend or twist LCD module in handling.
- 2、 Please design display housing in accordance with the following guide lines.
- 3、 Housing case must be destined carefully so as not to put stresses on LCD all sides and not to wrench module. The stresses may cause non-uniformity even if there is no non-uniformity statically.
- 4、 Keep sufficient clearance between LCD module back surface and housing when the LCD module is mounted. The clearance in the design is recommended taking into account the tolerance of LCD module thickness and mounting structure height on the housing.
- 5、 Please do not push or scratch LCD panel surface with any-thing hard. And do not soil LCD panel surface by touching with bare hands. (Polarizer film, surface of LCD panel is easy to be flawed.)
- 6、 Please do not press any parts on the rear side such as source IC, gate IC, and FPC during handling LCD module. If pressing rear part is unavoidable, handle the LCD module with care not to damage them.
- 7、 Please wipe out LCD panel surface with absorbent cotton or soft cloth in case of it being soiled.
- 8、 Please wipe out drops of adhesives like saliva and water on LCD panel surface immediately. They might damage to cause panel surface variation and color change. 11.2.7 Please do not take a LCD module to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.

8.3 Disassembling or Modification

Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. Leadtek does not warrant the module, if customers disassemble or modify the module.

8.4 Breakage of LCD Panel

- 1、 If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin.
- 2、 If liquid crystal contacts mouth or eyes, rinse out with water immediately.
- 3、 If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.
- 4、 Handle carefully with chips of glass that may cause injury, when the glass is broken.

8.5 Absolute Maximum Ratings and Power Protection Circuit

- 1、 Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts' parameters, environmental temperature, etc., otherwise LCD module may be damaged.
- 2、 Please do not leave LCD module in the environment of high humidity and high temperature for a long time.
- 3、 It's recommended employing protection circuit for power supply.

11.6 Operation

- 1 、 Do not touch, push or rub the polarizer with anything harder than HB pencil lead. Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.
- 2、 When the surface is dusty, please wipe gently with absorbent cotton or other soft material.
- 3 、 Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.
- 4 、 When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzine or other adequate solvent.

8.6 Static Electricity

- 1 、 Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.
- 2、 Because LCD module uses CMOS-IC on TFT-LCD panel, it is very weak to electrostatic discharge. Please be careful with electrostatic discharge.
- 3 、 Persons who handle the module should be grounded through adequate methods.

8.7 Disposal

When disposing LCD module, obey the local environmental regulations.

8.8 OTHERS

- 1 、 A strong incident light into LCD panel might cause display characteristics' changing inferior because of polarizer film, color filter, and other materials becoming inferior. Please do not expose LCD module direct sunlight land strong UV rays.
- 2、 Please pay attention to a panel side of LCD module not to contact with other materials in preserving it alone.
- 3、 For the packaging box, please pay attention to the followings:
- 4、 Packaging box and inner case for LCD are designed to protect the LCDs from the damage or scratching during transportation. Please do not open except picking LCDs up from the box.
- 5、 Please do not pile them up more than 6 boxes. (They are not designed so.) And please do not turn over.
- 6、 Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.
- 7、 Packing box and inner case for LCDs are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)

9.0 Packing form-TBD



深圳市丽台电子有限公司

Shenzhen Leadtek Electronics Co.,Ltd

Incoming Inspection Standards

来料检验标准

Model No. / 产品型号: Applies 5.5~10.0 Inch Touch Display ScreenUpdated Date / 生效日期: 2022-05-20Version / 版本: A0

Customer confirmation : _____

Record of Revision / 修订履历

Version / 版本	Revision Record / 修订内容	Reviser / 修订人	Revision Date / 修订日期
V0	首发 / Starting	Green	2022.05.20

1.Scope of application /适用范围.

This document shall be applied to 5.5~10.0 inch touch display screen.

本文件适用于5.5~10.0 寸触摸显示屏.

2.Inspection conditions and environment /检验条件与环境.

2.1 Inspection Conditions /检验条件:

(1) Inspection Distance /检测距离: 35cm ±5cm.

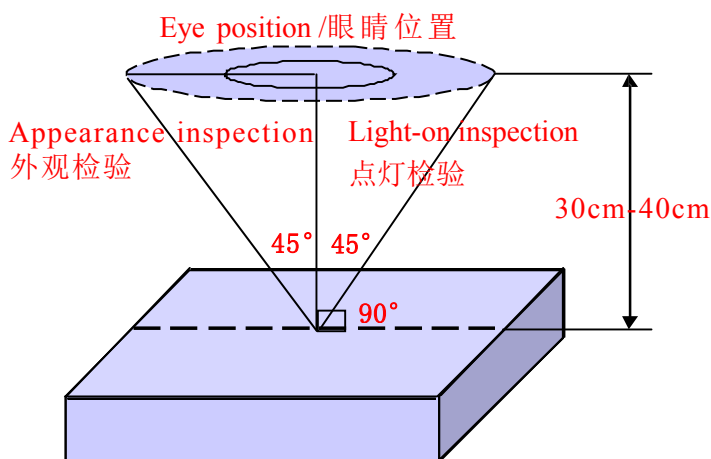
(2) Check time /检验时间:

Displays performance test /功能测试: 2~3S /Image, Cosmetic Inspection /外观检验:10~12S.

(3) Check the viewing angle /检验视角:

Light-on Inspection Angle /点灯检验角度: ±45°.

Cosmetic Inspection Angle /外观检验角度: ±45°.



(Perpendicular to LCD panel surface /垂直于LCD表面)

2.2 Inspection environment /检验环境:

Ambient Temperature 温度		25°C±5°C
Ambient Humidity 湿度		55±5%RH
Ambient Illumination 亮度	Cosmetic Inspection 外观检验	800-1000 Lux
	Functional Inspection 点灯检验	200~300Lux

2.3 Sampling Conditions /抽样条件:

(1) Quantity to be inspected /批量: Quantity of shipment lot per model /单次运送单一型号数量.

(2) Sampling method /抽样方法:

Sampling Plan /抽样计划		GB/T 2828.1- 2003
		Normal Inspection , Single Sampling 正常检验、单次抽样
		General inspection level: II 一般检验水平: 二级
AQL	Major Defect /主要缺陷	0.65
	Minor Defect /次要缺陷	1.0

(3) The classification of Major(MA) and Minor(MI) defects is shown as “3.1 Classification of defects” .
主缺(MA)及次缺(MI)定义于”3.1缺陷分类”.

3.Terms And Definitions /术语和定义

3.1 Classification of defects / 缺陷分类 :

(1) Major defects /主要缺陷:

A major defect is a defect that is likely to result in failure, or to reduce materially the usability of the product for its intended purpose .

可导致产品功能失效或减少产品可用性的缺陷.

(2) Minor defects /次要缺陷:

It will not cause the product to fail and reduce the defects in the effective use and operation of the product.

不会导致产品功能失效和减少产品的有效使用与操作的缺陷.

3.2 Point defects /点状缺陷:

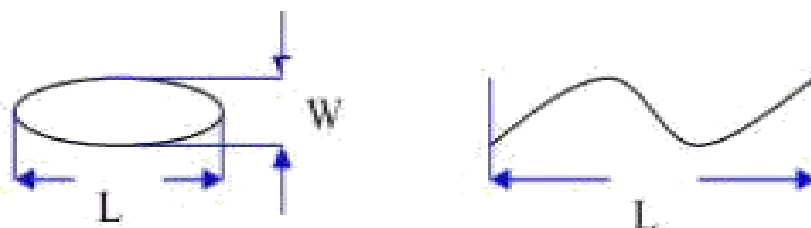
The size of the point defect is defined by the diameter D, and the average diameter of the defect is $D=1/2 (W+L)$.

点状缺陷的大小是由直径 D 定义的, 缺陷的平均直径 $D=1/2(W+L)$.

3.3 Linear defects /线状缺陷:

When defect size $L \geq 2W$, the defect count as liner type defect. Size of linear defect is defined by length (L) and the maximum width (W).

当缺陷尺寸 $L \geq 2W$ 时, 被视为线状缺陷, 线状缺陷是由长度 (L) 和最大宽度 (W) 定义的.



3.4 LCD sub-pixel dot /LCD子像素点

(1) Definition /定义 : The point defect area is greater than 50% of the LCD sub-pixel area, and is visible through ND5% filter masking .

子像素点缺陷面积大于 50% LCD子像素面积, 且透过 ND5%遮盖是可见的.

(2) The drawing of 1/2 area sub-pixel definition / 1/2 面积的子像素定义绘图:

The 1/2 area sub-pixel can be defined as below one or more of specific shapes

1/2 面积的子像素可以定义为如下一个或多个特定形状图:



3.5 Small bright dot /细碎亮点 :

Point defects smaller than "LCD sub-pixels" /小于“LCD子像素点”的点缺陷.

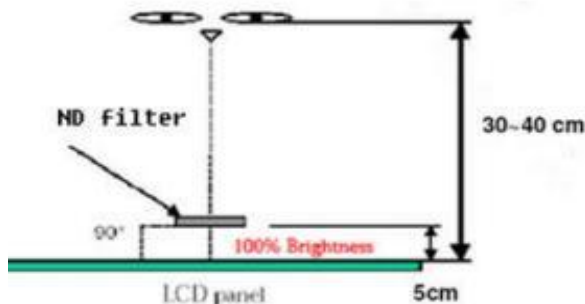
(Ratio of Zone I to Zone O / I 区与 O 区比例: 1: 2: 1)



3.6 ND filter inspection method /ND卡的检验方法:

Hold the ND filter about 5cm above the display area, with your eyes 30-40cm away from the panel, and observe for 2~3 seconds.

在显示区域上方大约 5cm 处握住 ND 卡, 眼睛距离面板 30-40cm, 观察2~3 秒.



3.7 Any FPC surface problems that do not leak copper on the surface and do not cause functional failure are acceptable.

任何 FPC 表面问题, 表面未露铜和不造成功能失效是可以接受.

3.8 Extraneous substances that can be wiped out , like Finger point,Particles are not considered as a defect .

可以被擦拭干净的表面物质不视为缺陷 (如手指印, 尘粒) .

3.9 Defects that can be covered by the material and are not visible in appearance are not considered defects.

能被物料覆盖，外观不可见的缺陷不视为缺陷。

3.10 Panel damage /面板损伤：

Glass damage outside the AA display area that does not affect the effective wiring is acceptable.

AA 显示区域以外的玻璃损伤，不影响有效线路是可以接受的。

3.11 Issues not specified or defined in this acceptance standard shall be handled through friendly negotiation between the two parties.

本允收标准中未规定或定义的问题，双方友好协商处理。

4. Inspection standards /检验标准

4.1 Structural Dimensions /结构尺寸规格

Serial Number 序号	Measurement items /测量项目		Specification /规格	Remark /备注
	名称 /Name	Unit /单位	Tolerance /公差	
1	Outside dimension: Length 尺寸：长	mm /毫米	0.15mm~0.30mm	Please refer to the product specification for detailed dimensions and tolerances 详细的尺寸规格和公差请参考产品规格书
2	Outside dimension: Width 尺寸：宽	mm /毫米	0.15mm~0.30mm	
3	Outside dimension: Thickness 尺寸：高	mm /毫米	0.20mm~0.50mm	

4.2 Appearance Inspection Specification /外观检验规格

(D : diameter, W : width, L : length, N : quantity, DS : spacing)

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
Glass 玻璃	Wire(on Array) 线路	Can't be damaged 不能损伤	MA	
	Chipping/corner breaking 崩边/破角	Can't affect the effective lines and functions 不能影响有效线路和功能	MA	
	Edge 边缘	There must be no extensional cracks 不可有延伸性裂纹	MA	
Silicone 硅胶	Silicone coating 硅胶涂布	The height must not exceed the LCD CF surface 高度不能超过LCD CF面		MI
	Glue overflow 溢胶	Can't cover FPC, POL, etc 不能覆盖到FPC、POL等		MI

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
PCBA FPC Connector 连接器	Appearance 外观	Scratches or injuries are not allowed to cause copper exposure 划伤或损伤不允许表面出现露铜		MI
	Component 元器件	Can't be damaged and lack 不能损伤和缺少	MA	
	Goldfinger oxidation 金手指氧化	Not allowed 不允许		MI
	Connection status 连接状况	The connection must be accurate and stable 必须准确稳定连接	MA	
	Break 破裂	Not allowed 不允许	MA	
	Soldering, false soldering/tinning/tin beads 假焊/连锡/锡珠	Not allowed 不允许	MA	
POL 偏光片	Scratches 划伤	1. $W \leq 0.07\text{mm}$; $L \leq 5\text{mm}$, Ignore (忽略) 2. $0.07\text{mm} < W \leq 0.12\text{mm}$; $L \leq 5\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.12\text{mm} < W$; $5\text{mm} < L$, Not allowable (不允许)		MI
	Dent 凹凸印	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
	Bubbles 气泡	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
	Point defects 点状不良	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
	Edge bubbles 边缘气泡	1. Within 1/2BM of the display area, it is not allowed 显示区往外 1/2BM 区域内, 不允许 2. The display area is 1/2 outside the BM area, and it is not controlled 显示区往外1/2BM区域以外, 不管控		MI
	Dirty/watermarked 脏污/水印	No dirt/water lines/finger marks are allowed, and must be wiped clean 不允许有脏污/水纹/手指印, 须擦拭干净方可		MI
	Warping 起翘	Not allowed 不允许		MI
	Attaching offset 贴偏	It is necessary to completely cover the display area outward, within the 1/2BM area, or without leaking POL edges after TP is attached 需完整覆盖显示区往外、1/2BM区以内或贴合TP后不会出现漏偏光片边缘		MI
	Mixture 混料	Mixing different types of POL or not using POL as required by the BOM, not allowed 不允许混贴不同型号的POL或未按BOM要求使用POL	MA	

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
TP&CG	Point defects 点状不良	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
	Scratches 划伤	1. $W \leq 0.07\text{mm}$; $L \leq 5\text{mm}$, Ignore (忽略) 2. $0.07\text{mm} < W \leq 0.12\text{mm}$; $L \leq 5\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.12\text{mm} < W$; $5\text{mm} < L$, Not allowable (不允许) 4. There is a feeling scratch, Not allowable 有感划伤, 不允许		MI
	Edges and corners cracked 崩角/崩边	1. Product front / 产品正面: Edge and corner chipping is not allowed 崩角、崩边不允许 2. Product back / 产品背面: $X \leq 0.5$, $Y \leq 0.5$, $Z \leq 1/2T$; $N \leq 4$; $DS \geq 10\text{mm}$		MI
	Silk screen 丝印	The silk screen is clear, complete and correct 丝印清晰、完整、内容正确		MI
	Dirty 脏污	Non-wipeable dirt, not allowed 不可擦拭的脏污, 不允许		MI
	Broken 破损	Not allowable 不允许	MA	
	Ink color aberration 油墨色差	$\Delta E > 1$, Not allowable (不允许)		MI
	Cover pinholes 针孔	1. $D \leq 0.15\text{mm}$, $N \leq 4$, $DS \geq 10\text{mm}$, allowable 2. $D > 0.15\text{mm}$, intensive pinholes (密集型针孔), Not allowable (不允许)		MI
	IR holes IR孔	Dirt, deviation, color difference, etc. are not allowed 不允许脏污、偏位、色差等		MI
BL 背光	Backlight separation 背光分离	Not allowable 不允许		MI
	Deformation of rubber iron and rubber frame 胶铁、胶框变形	Use the plug gauge 0.3mm on the flat surface and can snap in and judge NG 在平面上使用塞规0.3mm卡翘曲位置, 能卡进判定NG		MI
	The iron frame is oxidized and not tightened 铁框氧化、卡不紧	Not allowable 不允许		MI
	Backlight sticky solder beads, glue, etc 背面粘锡珠、残胶等	Not allowable 不允许		MI
	Inkjet coding, Barcode, QR code 喷码/条码/二维码	The Inkjet coding is clear and complete, the barcode and QR code can be scanned normally, and the content and format match 喷码清晰完整、条码和二维码可正常扫描, 内容和格式相符		MI
	Accessories(protective film, double-sided tape, insulating adhesive, etc.) 辅料(保护膜、双面胶、绝缘胶等)	Defects such as missing pastes, sticking deviations, defects, and fractures are not allowed 不允许有漏贴、贴偏、残缺、断裂等缺陷		MI

4.3 Electrical test specifications /电性检查规格

(D : diameter, W : width, L : length, N : quantity, DS : spacing)

Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
Glass bright spots/dark spots 玻璃亮点/暗点	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
Mura	Use ND5% filter masking, visual invisibility is OK, 200~300Lux 使用ND5%遮盖, 目视不可见即为OK, 200~300Lux		MI
Small bright dot 细碎亮点	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖, 目视不可见即为OK		MI
Light leakage 漏光	1. Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖, 目视不可见即为OK 2. If necessary, sign off on the sample 必要时, 签限定样		MI
Backlight black/white dots 背光黑点/白点	1. $D \leq 0.20\text{mm}$, Ignore (忽略) 2. $0.20\text{mm} < D \leq 0.40\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.40\text{mm} < D$, Not allowable (不允许)		MI
Linear foreign bodies 线状异物 (异物毛丝等)	1. $W \leq 0.07\text{mm}$; $L \leq 5\text{mm}$, Ignore (忽略) 2. $0.07\text{mm} < W \leq 0.12\text{mm}$; $L \leq 5\text{mm}$; $N \leq 4$; $DS \geq 10\text{mm}$ 3. $0.12\text{mm} < W$; $5\text{mm} < L$, Not allowable (不允许)		MI
Black/White Print 黑印/白印	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖, 目视不可见即为OK		MI
The display is uneven 显示不均匀	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖, 目视不可见即为OK		MI
The brightness is uneven 亮度不均匀	Brightness uniformity $< 85.0\%$, Not allowable 亮度均匀性 $< 85.0\%$, 不允许		MI
Displacement of the membrane 膜材移位	Not allowable 不允许		MI
Interference pattern/Newtonian pattern 干涉纹/牛顿纹	Not allowable 不允许		MI
Display abnormal 显示异常	Not allowable 不允许	MA	
No display 无显示	Not allowable 不允许	MA	
Line/Missing Drawing 线条/缺画	Not allowable 不允许	MA	
Splash screen 闪屏	Not allowable 不允许	MA	
LCD grid LCD网格	Not allowable 不允许	MA	
Afterimage 残影	Not allowable 不允许	MA	
Wrong viewing angle 视角错误	Not allowable 不允许	MA	
No touch 无触摸	Not allowable 不允许	MA	
Touch the jump point 触摸跳点	Not allowable 不允许	MA	
Not sensitive 触摸不灵敏	Not allowable 不允许	MA	